

	Hits	Search Text	DBs
2	1	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4) same (pattern or circuit\$4 or line)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (back or rear or backside or rearside) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)) same fir\$5)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hit s	Search Text	DBs
3	1	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$\$block\$4 or glass) same (pattern or circuit\$4 or line or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (back or rear or backside or rearside) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet))) same fir\$5)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
4	1	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$\$block\$4 or glass) same (pattern or circuit\$4 or line or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (back or rear or backside or rearside) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
5	29	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or line or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
6	6	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$4block\$4 or glass\$2) same (pattern or circuit\$4 or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer or application or apply\$5 or (doctor near5 blad\$4)) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)) same fir\$5) and ((expos\$4 or irradiat\$4 or illuminat\$4) same (rearside or (rear near9 surface) or backside or transparenc\$4))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hit s	Search Text	DBs
7	0	(multi\$4layer near9 circuit near9 board) and ((transfer or (green near5 sheet) or substrate or carrier) same (transmit\$5 or transparent or (light near4 transmit\$4) or glass\$2) same (pattern near9 (circuit\$4 or wiring or conductive or metal\$3))) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) near22 (ceramic or slurr\$4 or paste) near26 (coat\$4 or deposit\$4 or layer or application or apply\$5 or (doctor near5 blad\$4) near33 (pattern or via or trench or hole)) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)) same firing) and ((expos\$4 or irradiat\$4 or illuminat\$4) same (rearside or (rear near9 surface) or backside or (both near9 side) or (transparen\$4 near5 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
8	0	(multi\$4layer near9 circuit near9 board) and ((pcb or (printed near4 circuit)) same (transmit\$5 or transparent or (light near4 transmit\$4) or glass\$2) same (pattern near19 (circuit\$4 or wiring or conductive or metal\$3))) and (((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) near22 (ceramic or slurr\$4 or paste) near26 (coat\$4 or deposit\$4 or layer or application or apply\$5 or (doctor near5 blad\$4)) near33 (circuit near9 (board or panel or substrate or carrier or sheet))) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)) same firing) and ((expos\$4 or irradiat\$4 or illuminat\$4) same (rearside or (rear near9 surface) or backside or (both near9 side) or (transparen\$4 near5 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
9	0	(multi\$4layer near9 circuit near9 board) and ((pcb or (printed near4 circuit)) same (transmit\$5 or transparent or (light near4 transmit\$4) or glass\$2) same (pattern near19 (circuit\$4 or wiring or conductive or metal\$3))) and (((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) near22 (ceramic or slurr\$4 or paste) near26 (coat\$4 or deposit\$4 or layer or application or apply\$5 or (doctor near5 blad\$4)) near33 (circuit near9 (board or panel or substrate or carrier or sheet))) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)) same firing)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hit s	Search Text	DBs
10	29	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or line or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
11	18	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4 or paste) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet))) and firing	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
12	7	S10 NOT S11	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
13	18	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4 or paste) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet))) and firing	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB